

11-20-1998

OVER SHEET  
ILYU.S. Department of Commerce  
Patent and Trademark Office  
Attorney Docket No. 05823.0121To the Honorable Commissic  
Please record the attached oi.

100904859

ATTN. BOX ASSIGNMENTS

1. Name of conveying party(ies):

Kil Yeong CHOI, Jae Heung LEE, Sung Goo LEE,  
Mi Hie YI and Seung Su KIM

11/18/98

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment ☐ Merger  
☐ Security Agreement ☐ Change of Name

☐ Other

Execution Date: October 8, 1998

2. Name and address of receiving party(ies):

Name: KOREA RESEARCH INSTITUTE OF CHEMICAL  
TECHNOLOGY

Internal Address:

Street Address: 100, Jang-dong, Yusung-ku,  
Daejeon 305-343, Republic of Korea

City:

State:

Zip Code:

Additional name(s) &amp; Address(es) attached?

☐ Yes ☒ No

4. Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application:

A. Patent Application Number(s):

09/151,735

B. Patent Number(s):

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Mr. Ernest F. Chapman

Internal Address: FINNEGAN, HENDERSON, FARABOW, GARRETT  
& DUNNER, L.L.P.

11/19/1998 JSHADAZZ 00000205 09151735

01 FC:581

40.00 DP

Street Address: 1300 I Street, N.W.

City: Washington

State: DC Zip: 20005-3315

6. Total number of applications and registrations involved:  
17. Total fee (37 CFR 3.41): \$40  
☒Enclosed (Please charge deficiency to deposit account)  
☐

Authorized to be charged to deposit account

8. Deposit account number: 06-0916 E

9. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Dennis P. O'Reilley

Signature

November 18, 1998

Date

Total number of pages including cover sheet, attachments and documents: 3

## A S S I G N M E N T

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled: PREPARATION OF POLYIMIDE FOAM

for which I/We executed an application for United States Letters Patent concurrently herewith or on \_\_\_\_\_ or filed an application for United States Letters Patent on September 11, 19 98 (Serial No. 09/151,735); and

WHEREAS, KOREA RESEARCH INSTITUTE OF CHEMICAL TECHNOLOGY, a corporation of Republic of Korea, whose post office address is 100, Jang-dong, Yusung-ku, Daejeon 305-343, Republic of Korea (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application:

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from assignee is hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, my/our entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/We hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Agreement:


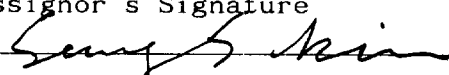
AND, I/WE HEREBY further covenant and agree that I/We will, without further consideration, communicate with assignee, its successors and assigns, any fact known to me/us respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

AND, I/WE HEREBY authorize and request the attorneys I/We have empowered in the Declaration and Power of Attorney in this application, to insert here in parentheses (Application No. 09/151,735, filed September 11, 1998) the filing date and application number of said application when known.

IN TESTIMONY WHEREOF, I/We have hereunto set out hand(s).

|   |                          |
|---|--------------------------|
| 1. Full Name of Sole or First Assignor : Assignor's Signature                               | : Date                   |
| <u>Kil Yeong CHOI</u>   | : <u>October 8, 1998</u> |
| Address   | : Citizenship            |
| <u>101-904, Hyundai Apt., 431-6, Doryong-dong, Yusung-ku, Daejeon 305-340,</u>              |                          |
| <u>Republic of Korea</u>  | : <u>Korean</u>          |
| 2. Full Name of Second Assignor : Assignor's Signature                                      | : Date                   |
| <u>Jae Heung LEE</u>  | : <u>October 8, 1998</u> |
| Address   | : Citizenship            |
| <u>108-103, Hanbit Apt., 99, Uheun-dong, Yusung-ku, Daejeon 305-333, Republic of Korea</u>  | : <u>Korean</u>          |
| 3. Full Name of Third Assignor : Assignor's Signature                                       | : Date                   |
| <u>Sung Goo LEE</u>   | : <u>October 8, 1998</u> |
| Address   | : Citizenship            |
| <u>110-1201, Hanbit Apt., 99, Uheun-dong, Yusung-ku, Daejeon 305-333, Republic of Korea</u> | : <u>Korean</u>          |

FINNEGAN, HENDERSON, FARABOW, GARRETT & DUNNER, L.L.P. WASHINGTON, D.C

|  |  |                   |
|--|--|-------------------|
| 4. Full Name of Fourth Assignor  | : Assignor's Signature   | : Date            |
| Mi Hie Yi  | :   | : October 8, 1998 |
| Address  |  | : Citizenship     |
| 109-304, Sejong Apt., Chunmin-dong, Yusung-ku, Daejeon 305-390, Republic of Korea  |  | : Korean          |
| 5. Full Name of Fifth Assignor   | : Assignor's Signature   | : Date            |
| Seung Su KIM   | :  | : October 8, 1998 |
| Address  |  | : Citizenship     |
| 6-201, Karackplaza Apt., Karack2-dong, Songpa-ku, Seoul 138-162, Republic of Korea |  | : Korean          |
| 6. Full Name of Sixth Assignor   | : Assignor's Signature   | : Date            |
|  |  | :                 |
| Address  |  | : Citizenship     |
|  |  | :                 |
| 7. Full Name of Seventh Assignor   | : Assignor's Signature   | : Date            |
|  |  | :                 |
| Address  |  | : Citizenship     |
|  |  | :                 |
| 8. Full Name of Eighth Assignor  | : Assignor's Signature   | : Date            |
|  |  | :                 |
| Address  |  | : Citizenship     |
|  |  | :                 |
| 9. Full Name of Ninth Assignor   | : Assignor's Signature   | : Date            |
|  |  | :                 |
| Address  |  | : Citizenship     |
|  |  | :                 |
| 10. Full Name of Tenth Assignor  | : Assignor's Signature   | : Date            |
|  |  | :                 |
| Address  |  | : Citizenship     |
|  |  | :                 |
| 11. Full Name of Eleventh Assignor   | : Assignor's Signature   | : Date            |
|  |  | :                 |
| Address  |  | : Citizenship     |
|  |  | :                 |
| 12. Full Name of Twelfth Assignor  | : Assignor's Signature   | : Date            |
|  |  | :                 |
| Address  |  | : Citizenship     |
|  |  | :                 |